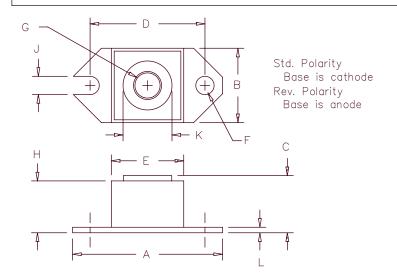
120 Amp Schottky Rectifier HS12035 — HS12045



Dim. Inches			Millimeter		
	Minimum	Maximum	Minimum	Maximum	Notes
А	1.52	1.56	38.61	39.62	
В	.725	.775	18.42	19.69	
С	.605	.625	15.37	15.88	
D	1.182	1.192	30.02	30.28	
Ε	.745	.755	18.92	19.18	Sq.
F	.152	.160	3.86	4.06	Dia.
G	3 1/4-20 UNC-2B				
Н	.525	.580	13.34	14.73	
J	.156	.160	3.96	4.06	
K	.495	.505	12.57	12.83	Dia.
L	.120	.130	3.05	3.30	

Microsemi Catalog Number	Industry Part Number	Working Peak Reverse Voltage	Repetitive Peak Reverse Voltage
HS12035*	120NQ035 124NQ035 MBR12035	35V	35V
HS12040*	120NQ040 124NQ040 MBR12040	40V	40V
HS12045*	120NQ045 124NQ045 MBR12045	45V	45V
;	* Add Suffix R	for Reverse Polarit	.v

- Schottky Barrier Rectifier
- Guard Ring Protection
- 120 Amperes/45 Volts
- 150°C Junction Temperature
- Reverse Energy Tested
- VRRM 35 45 Volts
- ROHS Compliant

Electrical Characteristics

F(AV) 120 Amps $^{T}C = 100^{\circ}C$, Square wave, $^{R}\Theta JC = .40^{\circ}C/W$ Average forward current ^lFSM Maximum surge current 2000 Amps 8.3ms, half sine, TJ = 125°C f = 1 KHZ, 25°C |FM = 120A: TJ = 125°C* Maximum repetitive reverse current R(OV) 2 Amps Max peak forward voltage 0.49 Volts TFM = 120A: TJ = 25°C* VRRM, TJ = 125°C* VRRM, TJ = 25°C VFM 0.55 Volts Max peak forward voltage 1_{RM} Max peak reverse current 2A ^IRM Max peak reverse current 5mA $VR = 5.0V, TC = 25^{\circ}C$ C_{J} 5500pF Typical junction capacitance *Pulse test: Pulse width 300 µsec, Duty cycle 2%

Thermal and Mechanical Characteristics

 $\mathsf{T}_{\mathsf{STG}}$ Storage temp range -55°C to 150°C ΤJ -55℃ to 150℃ Operating junction temp range ROJC 0.40°C/W Junction to case Max thermal resistance Recs 0.12°C/W Case to sink Typical thermal resistance (greased) 35-40 inch pounds Terminal Torque Mounting Base Torque 20-25 inch pounds 1.1 ounces (32 grams) typical Weight



HS12035 -HS12045

Figure 1 Typical Forward Characteristics

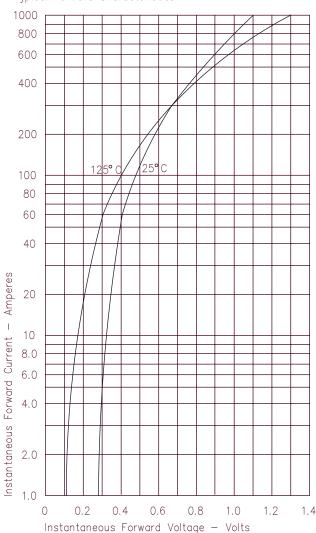


Figure 3 Typical Junction Capacitance 40000 Ы 20000 Capacitance 10000 6000 4000 Junction 2000 1000 .2 .5 1 2 10 20 50 100 Reverse Voltage - Volts

Figure 4 Forward Current Derating

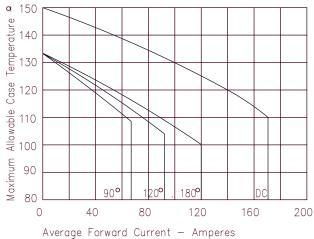


Figure 2 Typical Reverse Characteristics

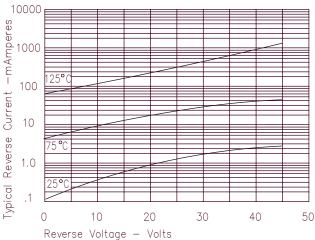
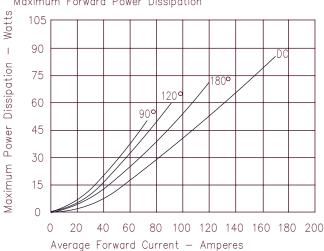


Figure 5 Maximum Forward Power Dissipation





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